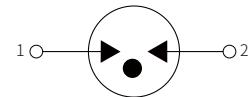


FEATURES

- | Size Design $\Phi 8.0*6.0\text{mm}$
- | High Current Handling Capability 3,000A @ 8/20 μs
- | Low Capacitance and Insertion Loss
- | Quick Response and Long Service Life
- | Moisture sensitivity level: Level 1



$\Phi 8.0*6.0\text{mm}$



Schematic Symbol

APPLICATION INFORMATION

- | Communication equipment.
- | Repeaters, Modems
- | Telephone Interface, Line cards.
- | Data communication equipment.

AGENCY APPROVALS

| Icon | Solderability |
|------|------------------------------------|
| RoHS | Compliance with 2011/65/EU |
| HF | Compliance with IEC61249-2-21:2003 |
| Pb | Mean lead free |

PRODUCT CHARACTERISTICS

| Lead Material | Body Material | Terminal Finish |
|-----------------------|---------------|-----------------------|
| Copper or Fe-Ni alloy | Ceramics | 100% Matte-Tin Plated |

ELECTRICAL PARAMETER

| Parameter | Symbol | Rating | Unit |
|-----------------------------------|---------------|--|------|
| DC Blocking Voltage 1) | 100V/s | 2400-3600 | V |
| Impulse Spark-over Voltage | At 1kV/μs | for 99 % of measured values ≤ 5000 | V |
| | At 1kV/μs | Typical values of distribution ≤ 4500 | V |
| Impulse Discharge Current 2) | 8/20μs | 3.0 | KA |
| Insulation Resistance | DC=1000V | ≥ 1.0 | GΩ |
| Capacitance at 1MHz | $V_{DC}=0.5V$ | ≤ 1.5 | pF |
| Operating and Storage Temperature | | -40~125 | °C |

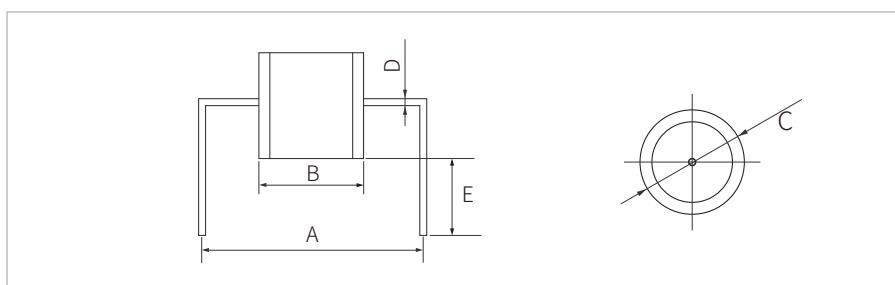
1) In ionized mode

2) Terms and waveforms in accordance with ITU-T Rec. K. 12; IIEC 61643-311

ENVIRONMENTAL RELIABILITY CHARACTERISTICS

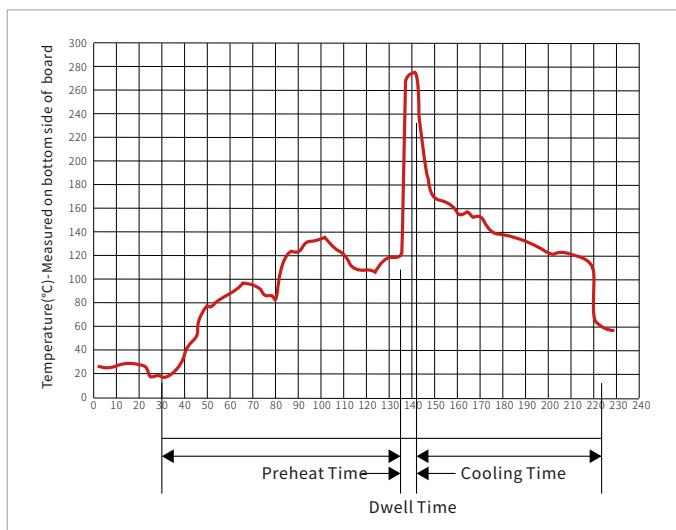
| Testing items | Technical standards |
|-------------------------------|---|
| High Temperature Storage Test | Temperature: 85°C ; Time:2H |
| Low Temperature Storage Test | Temperature: -40°C ; Time:2H |
| Vibration | Frequency: 10-500Hz ; Amplitude:0.15mm ; Time:45min |
| Resistance of soldering heat | Temperature: 260°C; Time of dip soldering:10s,1time |

PRODUCT DIMENSIONS



| Ref. | Outline Dimensions |
|------|--------------------|
| | Millimeters |
| A | 10.2±0.5 |
| B | 6±0.2 |
| C | Φ8.0±0.2 |
| D | Φ0.8 |
| E | 3.5±0.3 |

WAVE SOLDERING



| Wave Parameter | Lead-free assembly |
|------------------------|--------------------------------|
| Pre Heat | Temperature Min 100°C |
| | Temperature Max 150°C |
| | Time(min to max) 60 – 180 secs |
| Solder pot Temperature | 280°C Max |
| Solder Dwell Time | 2-5 seconds |

ORDERING INFORMATION

| Part Number | Size | Marking | Qty/pcs | |
|--------------|------------|-----------|---------|--------|
| | | | Reel | Carton |
| SG2R08B3000B | Φ8.0*6.0mm | SG3000 08 | 1000 | 4000 |

Headquarters

No.3387 Shendu Road
Pujiang I&E Park
Minhang Shanghai China
201000

Hotline

400-021-5756

Web

[Https://www.semiware.com](https://www.semiware.com)

Sales Center

Tel: 86-21-3463-7458
Email: sales18@semiware.com

Customer Service

Tel: 86-21-5484-1001
Email: sales17@semiware.com

Technical Support

Tel: 86-21-3463-7654
Email: fae01@semiware.com

Complaint & Suggestions

Tel: 86-21-3463-7172
Ext: 8868
Email: cs03@semiware.com

By QR Code

Website



Wechat

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